

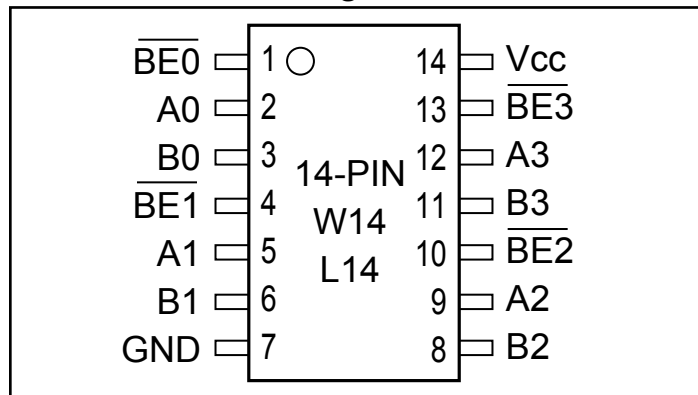
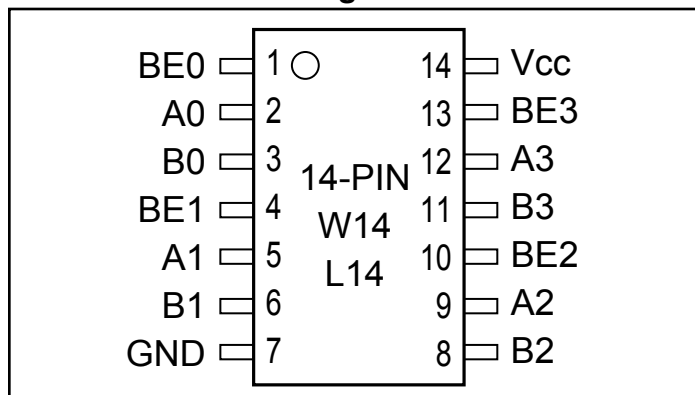
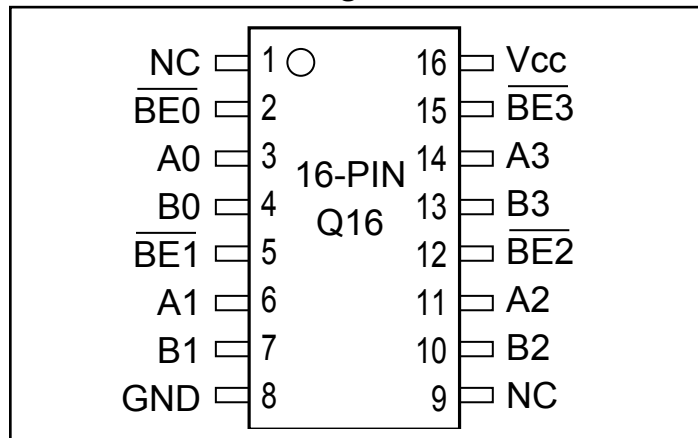
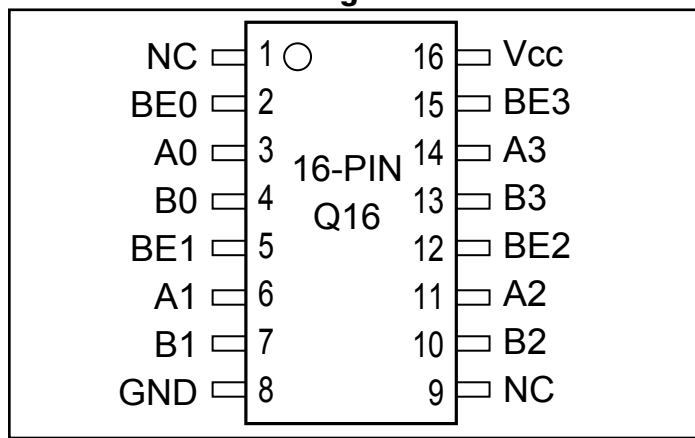
PI3C3125/PI3C3126
Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	-65°C to +150°C
Ambient Temperature with Power Applied	-40°C to +85°C
Supply Voltage to Ground Potential (Inputs & V _{CC} Only).....	-0.5V to +4.6V
Supply Voltage to Ground Potential (Outputs & D/O Only) ..	-0.5V to +4.6V
DC Input Voltage	-0.5V to +5.5V
DC Output Current.....	120mA
Junction Temperature.....	125°C

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

PI3C3125 14-Pin Configuration

PI3C3126 14-Pin Configuration

PI3C3125 16-Pin Configuration

PI3C3126 16-Pin Configuration

Pin Description

Pin Name	Description
$\overline{BEn}$	Switch Enable (PI3C3125)
BEn	Switch Enable (PI3C3126)
A3 - A0	Bus A
B3 - B0	Bus B
V _{CC}	Power
GND	Ground

Truth Table⁽¹⁾

PI3C3125 $\overline{BEn}$	PI3C3126 BEn	A _n	B _n	V _{CC}	Function
X*	X	Hi-Z	Hi-Z	GND	Disconnect
H	L	Hi-Z	Hi-Z	V _{CC}	Disconnect
L	H	B _n	A _n	V _{CC}	Disconnect

Note:

1. H = High Voltage Level, L = Low Voltage Level

Hi-Z = High Impedance, X = Don't Care

* A pull-up resistor should be provided for power-up protection.

PI3C3125/PI3C3126
DC Electrical Characteristics (Over Operating Range, $T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, $V_{CC} = 3.3\text{V} \pm 10\%$)

Parameters	Description	Test Conditions ⁽¹⁾	Min.	Typ. ⁽²⁾	Max	Units
V_{IH}	Input HIGH Voltage	Guaranteed Logic HIGH Level	2.0			V
V_{IL}	Input LOW Voltage	Guaranteed Logic LOW Level -0.5		0.8		
I_{IH}	Input HIGH current	$V_{CC} = \text{Max.}, V_{IN} = V_{CC}$			± 1	μA
I_{IL}	Input LOW Current	$V_{CC} = \text{Max.}, V_{IN} = \text{GND}$			± 1	μA
$I_{OZH}^{(3)}$	High Impedance Output Current	$0 \leq A, B \leq V_{CC}$			± 1	
V_{IK}	Clamp Diode Voltage	$V_{CC} = \text{Min.}, I_{IN} = -18\text{mA}$		-0.73	-1.2	V
R_{ON}	Switch ON Resistance ⁽⁴⁾	$V_{CC} = \text{Min.}, V_{IN} = 0.0\text{V}, I_{ON} = 48\text{mA}$ or 60mA $V_{CC} = \text{Min.}, V_{IN} = 2.4\text{V}, I_{ON} = 15\text{mA}$		5 8	7 15	Ω

Notes:

- For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at $V_{CC} = 3.3\text{V}$, $T_A = 25^{\circ}\text{C}$ ambient and maximum loading.
- Not more than one output should be shorted at one time. Duration of the test should not exceed one second.
- Measured by the voltage drop between A and B pin at indicated current through the switch. ON resistance is determined by the lower of the voltages on the two (A,B) pins.

Capacitance ($T_A = 25^{\circ}\text{C}$, $f = 1\text{ MHz}$)

Parameters ⁽¹⁾	Description	Test Conditions	Typ.	Units
C_{IN}	Input Capacitance	$V_{IN} = 0\text{V}$	3.5	pF
C_{OFF}	A/B Capacitance, Switch Off	$V_{IN} = 0\text{V}$	5.0	
C_{ON}	A/B Capacitance, Switch On	$V_{IN} = 0\text{V}$	10.0	

Notes:

- This parameter is determined by device characterization but is not production tested.

Power Supply Characteristics

Parameters	Description	Test Conditions		Min.	Typ. ⁽²⁾	Max.	Units
I_{CC}	Quiescent Power Supply Current	$V_{CC} = \text{Max}$	$V_{IN} = \text{GND}$ or V_{CC}		260	500	μA
ΔI_{CC}	Supply Current per Input HIGH	$V_{CC} = \text{Max}$	$V_{IN} = 3.0\text{V}^{(3)}$			750	

Notes:

- For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device.
- Typical values are at $V_{CC} = 3.3\text{V}$, $+25^{\circ}\text{C}$ ambient.
- Per driven input (control input only); A and B pins do not contribute to ΔI_{CC} .

PI3C3125/PI3C3126
PI3C3125/PI3C3126 Switching Characteristics over 3.3V Operating Range

Parameters	Description	Conditions	PI3C3125/PI3C3126		Units
			Com.		
			Min.	Max.	
t _{PLH} t _{PHL}	Propogation Delay ^(1,2) A to B, B to A	C _L =50pF R _L = 500Ω		0.25	ns
t _{PZH} t _{PZL}	Bus Enable Time	C _L =50pF R _L = 500Ω	1.5	6.5	
t _{PHZ} t _{PLZ}	Bus Disable Time	R = 500Ω	1.5	5.5	

Notes:

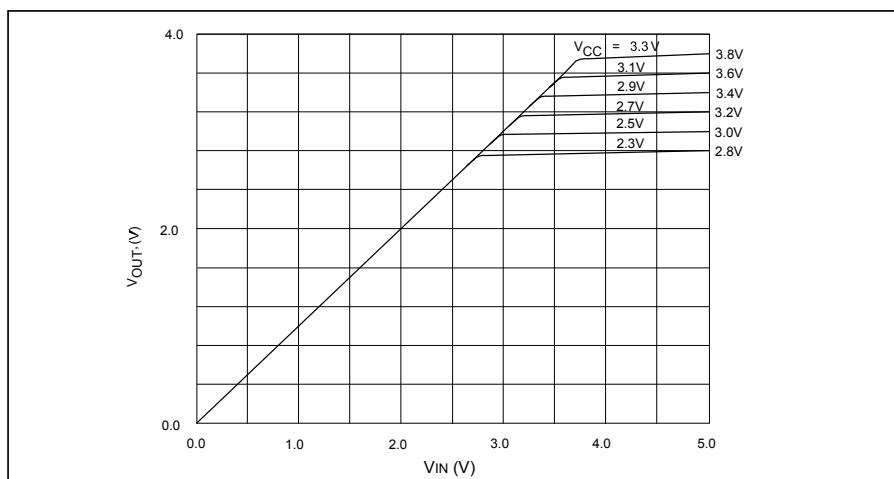
1. This parameter is guaranteed but not tested on Propagation Delays.
2. The bus switch contributes no propagational delay other than the RC delay of the ON resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.25ns for 50pF load. Since this time constant is much smaller than the rise/fall times of typical driving signals, it adds very little propagational delay to the system. Propagational delay of the bus switch when used in a system is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

PI3C3125/PI3C3126 Switching Characteristics over 2.5V Operating Range

Parameters	Description	Conditions	PI3C3125/PI3C3126		Units
			Com.		
			Min.	Max.	
t _{PLH} t _{PHL}	Propogation Delay ^(1,2) A to B, B to A	C _L =50pF R _L = 500Ω		0.25	ns
t _{PZH} t _{PZL}	Bus Enable Time	C _L =50pF R _L = 500Ω	1.5	9.8	
t _{PHZ} t _{PLZ}	Bus Disable Time	R = 500Ω	1.5	8.3	

Notes:

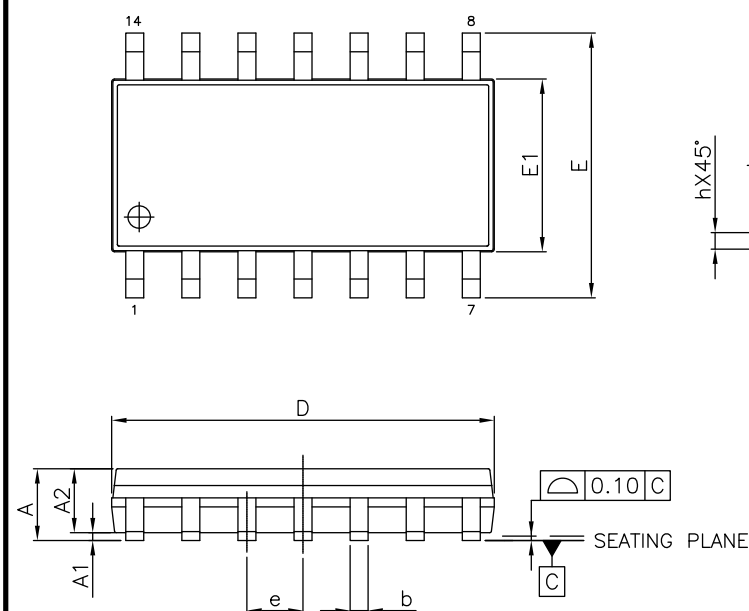
1. This parameter is guaranteed but not tested on Propagation Delays.
2. The bus switch contributes no propagational delay other than the RC delay of the ON resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.25ns for 50pF load. Since this time constant is much smaller than the rise/fall times of typical driving signals, it adds very little propagational delay to the system. Propagational delay of the bus switch when used in a system is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.



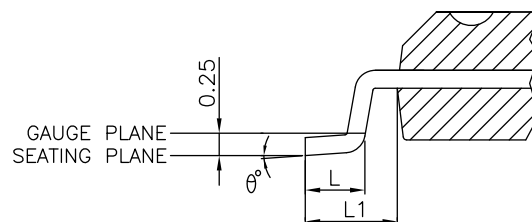
Switch Output Voltage vs. Input Voltage over Various Supply Voltages

PI3C3125/PI3C3126

Packaging Mechanical: 14-SOIC (W)



SYMBOLS	MIN.	NOM.	MAX.
A	—	—	1.75
A1	0.10	—	0.25
A2	1.25	—	—
b	0.31	—	0.51
c	0.10	—	0.25
D	8.55	8.65	8.75
E	5.80	6.00	6.20
E1	3.70	3.90	4.10
e	1.27 BSC		
L	0.40	—	1.27
L1	1.04 REF		
h	0.25	—	0.50
θ°	0	—	8



NOTES:
1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
2. JEDEC MS-012
3. DIMENSIONS DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.



DATE: 03/24/16

DESCRIPTION: 14-Pin, 150mil Wide SOIC

PACKAGE CODE: W (W14)

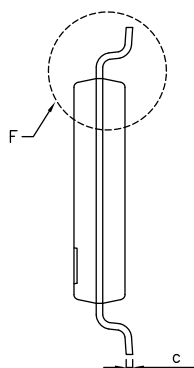
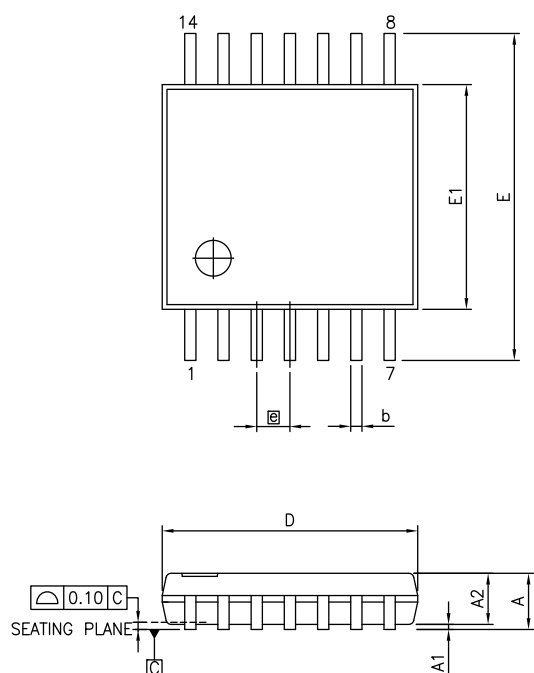
DOCUMENT CONTROL #: PD-1002

REVISION: E

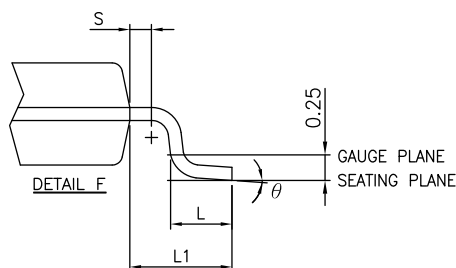
16-0055

PI3C3125/PI3C3126

Packaging Mechanical: 14-TSSOP (L)



SYMBOLS	MIN.	NOM.	MAX.
A	—	—	1.20
A1	0.05	—	0.15
A2	0.80	1.00	1.05
b	0.19	—	0.30
c	0.09	—	0.20
D	4.90	5.00	5.10
E1	4.30	4.40	4.50
E	6.20	6.40	6.60
e	0.65 BSC		
L1	1.00 REF		
L	0.45	0.60	0.75
S	0.20	—	—
θ	0°	—	8°



NOTES:

1. ALL DIMENSIONS IN MILLIMETERS. ANGLES IN DEGREES.
2. JEDEC MO-153F
3. DIMENSIONS DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.



DATE: 03/24/16

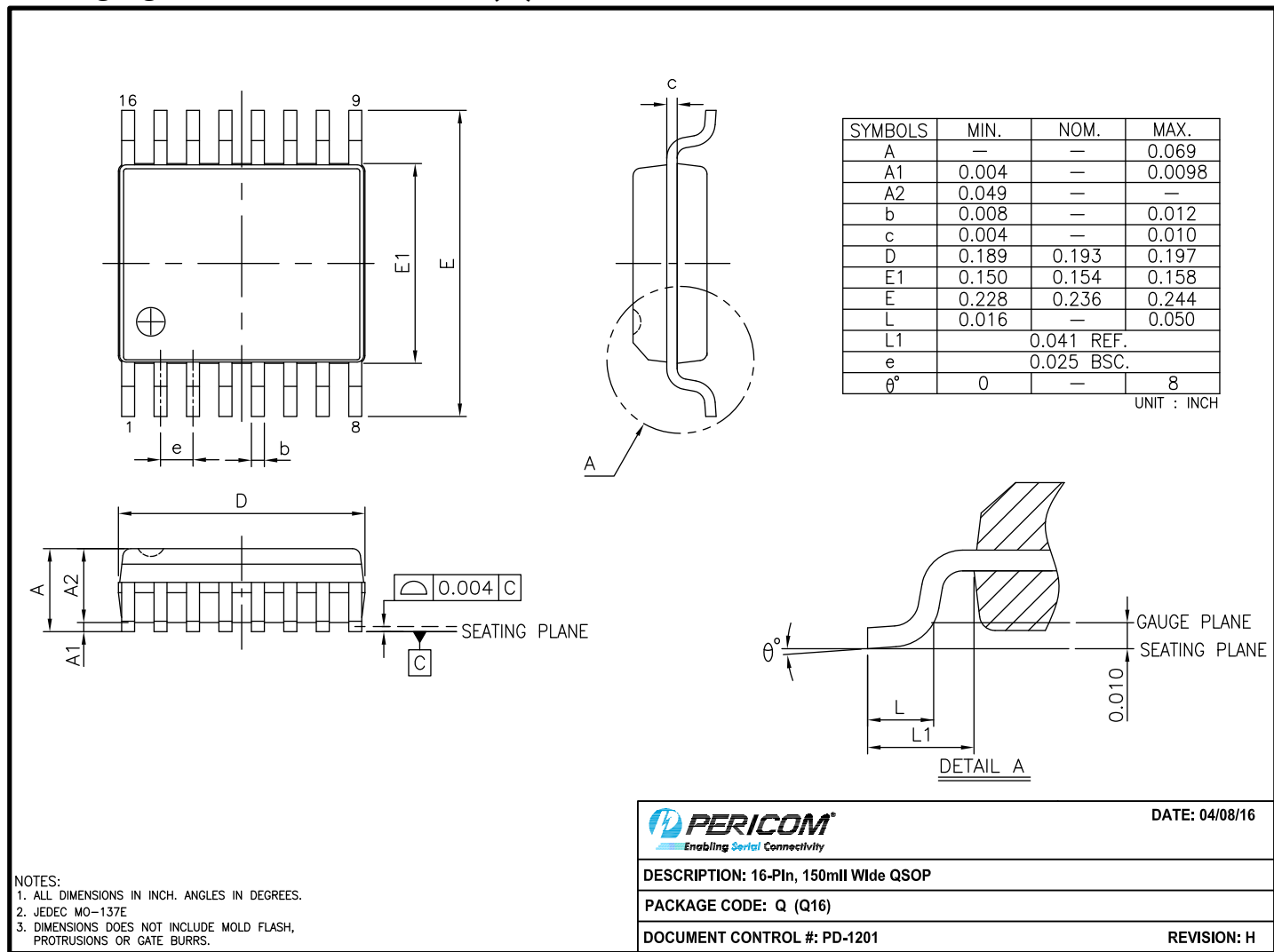
DESCRIPTION: 14-Pin, 173mil Wide TSSOP

PACKAGE CODE: L (L14)

DOCUMENT CONTROL #: PD-1309

REVISION: E

16-0060

PI3C3125/PI3C3126
Packaging Mechanical: 16-QSOP (Q)


16-0056

For latest package info.

 please check: <http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/>
Ordering Information

Ordering Code	Packaging Code	Description
PI3C3125LEX	L	14-pin, 173mil Wide (TSSOP)
PI3C3125WEX	W	14-pin, 150mil Wide (SOIC)
PI3C3126LEX	L	14-pin, 173mil Wide (TSSOP)
PI3C3126QEX	Q	16-pin, 150mil Wide (QSOP)

Notes:

- Thermal characteristics can be found on the company web site at www.diodes.com/design/support/packaging/
- E = Pb-free and Green
- X suffix = Tape/Reel

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